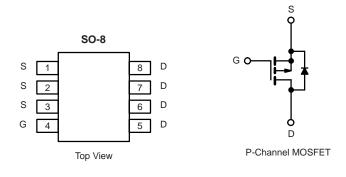


IRF7241TRPBF-VB Datasheet

P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
- 40	0.010 at V_{GS} = - 10 V	- 16.1	33 nC			
- 40	0.014 at V _{GS} = - 4.5 V	- 13.3	33110			



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- 100 % Rg Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Load Switch
- POL

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted Parameter Symbol Limit Unit Drain-Source Voltage - 40 V_{DS} V Gate-Source Voltage V_{GS} ± 20 T_C = 25 °C - 16.1 T_C = 70 °C - 12.9 Continuous Drain Current (T_J = 150 °C) I_D T_A = 25 °C - 10.2^{b, c} T_A = 70 °C - 8.2^{b, c} А **Pulsed Drain Current** - 50 I_{DM} T_C = 25 °C - 5.3 Continous Source-Drain Diode Current I_S T_A = 25 °C - 2.1^{b, c} Single Pulse Avalanche Current - 28 I_{AS} L = 0.1 mHSingle Pulse Avalanche Energy E_{AS} 39 mJ T_C = 25 °C 6.3 T_C = 70 °C 4 Maximum Power Dissipation P_D W T_A = 25 °C 2.5^{b, c} T_A = 70 °C 1.6^{b, c} T_J, T_{stg} °C Operating Junction and Storage Temperature Range - 55 to 150

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	37	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	16	20	0/11	

Notes

a. Based on $T_C = 25$ °C. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

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COMPLIANT

HALOGEN

FREE

1

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 36		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i _D = - 250 μA		5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1.2		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Cata Malta na Duain Currant	I _{DSS}	V _{DS} = - 40 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 25			Α	
		V _{GS} = - 10 V, I _D = - 10.2 A		0.010		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 8.4 A		0.014			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10.2 A		37		S	
Dynamic ^b	<u> </u>			•	<u> </u>	1	
Input Capacitance	C _{iss}			3007			
Output Capacitance	C _{oss}	V _{DS} = - 20 V, V _{GS} = 0 V, f = 1 MHz		335		pF	
Reverse Transfer Capacitance	C _{rss}			291			
Total Gate Charge		V _{DS} = - 20 V, V _{GS} = - 10 V, I _D = - 10.2 A		64	95	nC	
				33	50		
Gate-Source Charge	Q _{gs}	V _{DS} = - 20 V, V _{GS} = - 4.5 V, I _D = - 10.2 A		9.8			
Gate-Drain Charge	Q _{gd}			15.7			
Gate Resistance	R _g	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time	t _{d(on)}			57	86		
Rise Time	t _r	V_{DD} = - 20 V, R _L = 2.4 Ω		50	75	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 8.2 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		40	60		
Fall Time	t _f			17	26		
Turn-On Delay Time	t _{d(on)}			13	20	ns	
Rise Time	t _r	$V_{DD} = -20 \text{ V}, \text{ R}_{1} = 2.4 \Omega$		11	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 8.2 A, V_{GEN} = - 10 V, R_g = 1 Ω		45	68		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristi							
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 5.3	_	
Pulse Diode Forward Current	I _{SM}				- 50	A	
Body Diode Voltage	V _{SD}	I _S = - 8.2 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			36	54	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			41	62	nC	
Reverse Recovery Fall Time	t _a	$I_F = -8.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		20		ns	
Reverse Recovery Rise Time	t _b	1		16			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

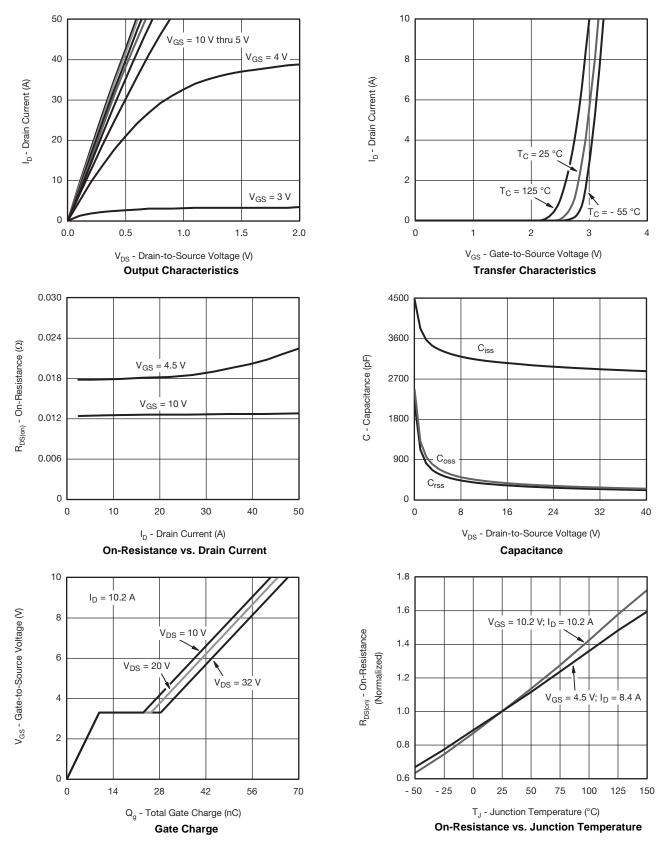
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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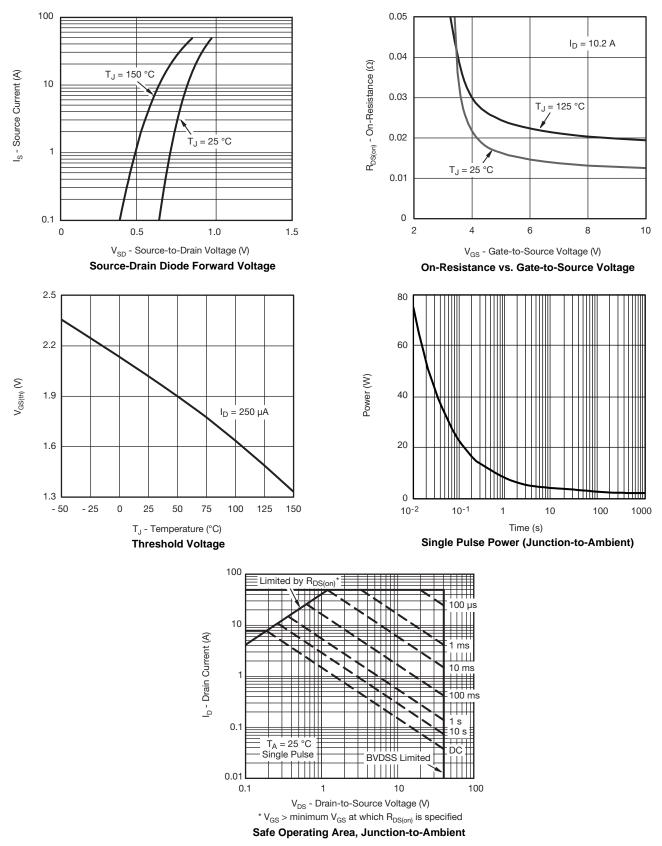






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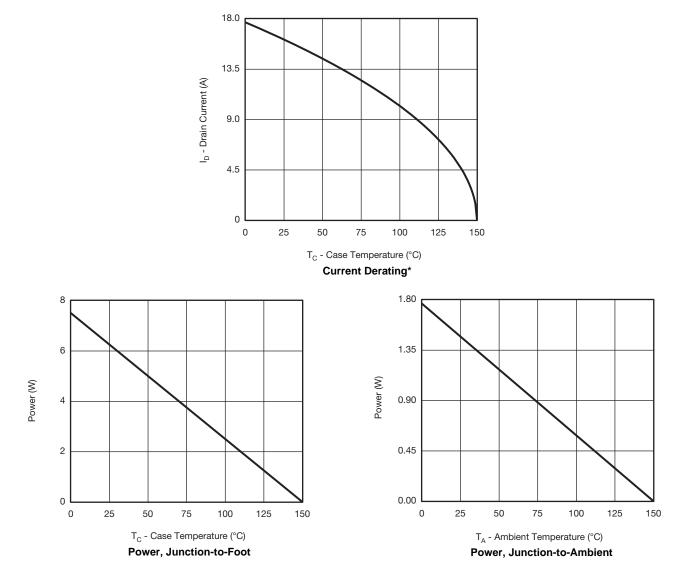




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



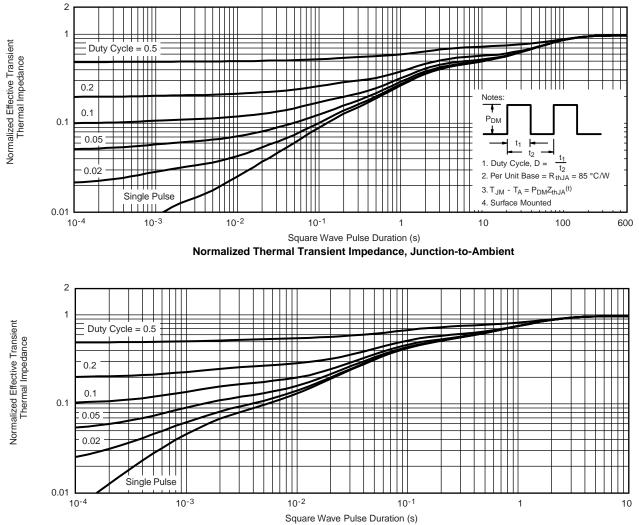
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

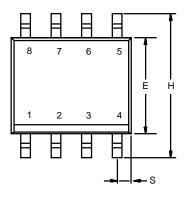


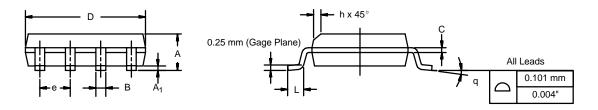
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

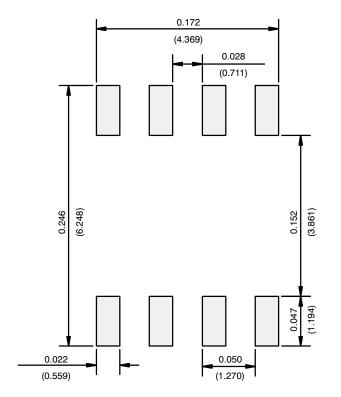




	MILLIMETERS		INCHES		
DIM	Min	Мах	Min	Max	
А	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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